

ICMM4 General Technical Program					
Location	Blum	Hearst	Bechtl	Sibley	Dai
<b>Wednesday, May 27</b>					
8:30-10:30 Registration	Gabrini Lounge				
Session 1: 10:30 - 12:00	<i>Micro- and Nano-Scale Modeling of hcp Alloys</i>	<i>Nonlinear Elasticity and Viscoelasticity</i>	<i>Plasticity and Viscoplasticity</i>	<i>Multiscale Modeling</i>	<i>Experimental Identification and Material Characterization</i>
Session 2: 1:30 - 3:00	<i>Micro- and Nano-Scale Modeling of hcp Alloys</i>	<i>Nonlinear Elasticity and Viscoelasticity</i>	<i>Plasticity and Viscoplasticity</i>	<i>Multiscale Modeling</i>	<i>Experimental Identification and Material Characterization</i>
Session 3: 3:30 - 5:00	<i>Micro- and Nano-Scale Modeling of hcp Alloys</i>	<i>Nonlinear Elasticity and Viscoelasticity</i>	<i>Plasticity and Viscoplasticity</i>	<i>Multiscale Modeling</i>	<i>Experimental Identification and Material Characterization</i>
<b>Thursday, May 28</b>					
Session 4: 8:30 - 10:00	<i>Micro- and Nano-Scale Modeling of hcp Alloys</i>	<i>Nonlinear Elasticity and Viscoelasticity</i>	<i>Dislocation Dynamics</i>	<i>Multiscale Modeling</i>	<i>Strain Gradient and Nonclassical Approaches</i>
Session 5: 10:30 - 12:00	<i>Micro- and Nano-Scale Modeling of hcp Alloys/Atomistic to Continuum Transitions</i>	<i>Nonlinear Elasticity and Viscoelasticity</i>	<i>Dislocation Dynamics</i>	<i>Multiscale Modeling</i>	<i>Strain Gradient and Nonclassical Approaches</i>
Session 6: 1:30 - 3:00	<i>Polymeric Materials</i>	<i>Nonlinear Elasticity and Viscoelasticity/Biomaterials</i>	<i>Dislocation Dynamics</i>	<i>Multiscale Modeling</i>	<i>Nanomechanics</i>
Session 7: 3:30 - 5:00	<i>Creep, Damage, Fracture, and Fatigue</i>	<i>Granular Materials and Particle Systems</i>	<i>Dislocation Dynamics</i>	<i>Multiscale Modeling/Statistical Mechanics</i>	
<b>Friday, May 29</b>					
Session 8: 8:30 - 10:00	<i>Creep, Damage, Fracture, and Fatigue</i>	<i>Composites</i>	<i>Phase-Transforming Materials</i>	<i>Multiscale Modeling/Multiferroic Materials</i>	
Session 9: 10:30 - 12:00	<i>Creep, Damage, Fracture, and Fatigue</i>	<i>Composites</i>	<i>Phase-Transforming Materials</i>	<i>Electronic Materials</i>	